Preferred Device

Silicon Controlled RectifiersReverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

Features

- Blocking Voltage to 800 Volts
- On–State Current Rating of 12 Amperes RMS at 80°C
- High Surge Current Capability 100 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum at 125°C
- Pb-Free Packages are Available*

MAXIMUM RATINGS (T_{.1} = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) (T _J = -40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) MCR12LD MCR12LM MCR12LN	V _{DRM,} V _{RRM}	400 600 800	V
On-State RMS Current (180° Conduction Angles; T _C = 80°C)	I _{T(RMS)}	12	Α
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 125°C)	I _{TSM}	100	А
Circuit Fusing Consideration (t = 8.3 ms)	l ² t	41	A ² sec
Forward Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 80°C)	P _{GM}	5.0	W
Forward Average Gate Power (t = 8.3 ms, T _C = 80°C)	P _{G(AV)}	0.5	W
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _C = 80°C)	I _{GM}	2.0	А
Operating Junction Temperature Range	TJ	-40 to 125	°C
Storage Temperature Range	T _{stg}	-40 to 150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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SCRs 12 AMPERES RMS 400 thru 800 VOLTS



MARKING DIAGRAM



TO-220AB CASE 221A-09 STYLE 3

A = Assembly Location

′ = Year

WW = Work Week x = D, M, or N

= Pb-Free Package

AKA = Diode Polarity

PIN ASSIGNMENT				
1	Cathode			
2	Anode			
3	Gate			
4	Anode			

ORDERING INFORMATION

Device	Package	Shipping
MCR12LD	TO-220AB	50 Units / Rail
MCR12LDG	TO-220AB (Pb-Free)	50 Units / Rail
MCR12LM	TO-220AB	50 Units / Rail
MCR12LMG	TO-220AB (Pb-Free)	50 Units / Rail
MCR12LN	TO-220AB	50 Units / Rail
MCR12LNG	TO-220AB (Pb-Free)	50 Units / Rail

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

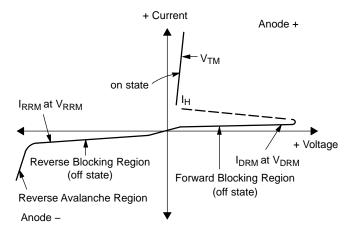
ol Min	Characteristic Sym	Min Typ	Max	Unit
	3			
, <u> </u>	d or Reverse Blocking Current $T_J = 25^{\circ}C$ I_{DRI} d V_{RRM} ; Gate Open) $T_J = 125^{\circ}C$ I_{RR}	 	0.01 2.0	mA
	·			
_	Voltage (Note 2) V _{TI}		2.2	V
2.0	ontinuous dc) I $_{G^{\gamma}}$	2.0 4.0	8.0	mA
4.0	n, Initiating Current = 200 mA)	4.0 10	20	mA
6.0	v, Ig = 20 mA)	6.0 12	30	mA
0.5	ontinuous dc) V_G	0.5 0.65	0.8	V
	STICS			
100	Off–State Voltage connential Waveform, Gate Open, T _J = 125°C)	100 250	_	V/μs
-	On–State Current di/ousec; diG/dt = 1 A/μsec, Igt = 50 mA		50	A/μs

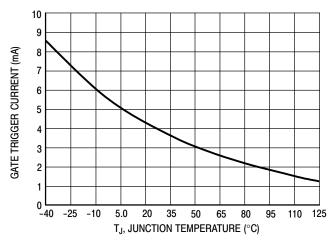
^{2.} Indicates Pulse Test: Pulse Width \leq 1.0 ms, Duty Cycle \leq 2%.

1.0

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
I _H	Holding Current

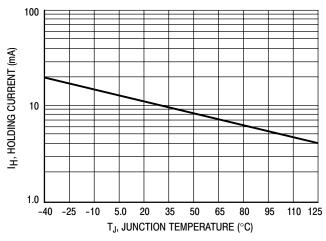




(\$\frac{\text{YIO}}{0.9} \\ \text{0.8} \\ \text{0.6} \\ \text{0.3} \\ \text{0.2} \\ \text{-40} \\ \text{-25} \\ \text{-10} \\ \text{5.0} \\ \text{20} \\ \text{35} \\ \text{50} \\ \text{65} \\ \text{80} \\ \text{95} \\ \text{110} \\ \text{125} \\ \text{TJ, JUNCTION TEMPERATURE (°C)}

Figure 1. Typical Gate Trigger Current versus Junction Temperature

Figure 2. Typical Gate Trigger Voltage versus Junction Temperature





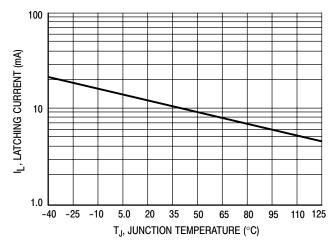
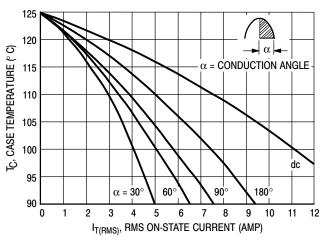


Figure 4. Typical Latching Current versus Junction Temperature

18

16

 $\rightarrow \alpha$



P(AV), AVERAGE POWER DISSIPATION (WATTS) 90° α = CONDUCTION ANGLE 14 12 $\alpha = 30^{\circ}$ 10 T_J = 125°C 5 8 10 $I_{T(AV)}$, AVERAGE ON-STATE CURRENT (AMPS)

Figure 5. Typical RMS Current Derating

Figure 6. On-State Power Dissipation

180°

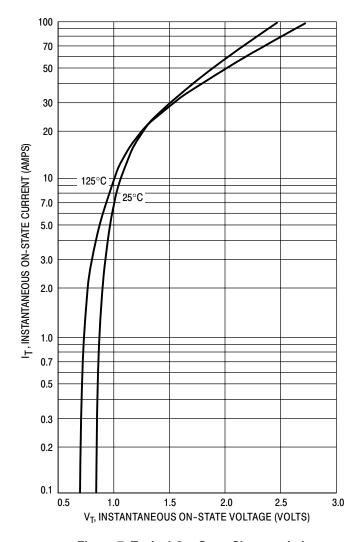
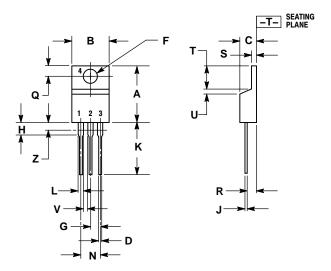


Figure 7. Typical On-State Characteristics

PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 **ISSUE AA**



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 3:

CATHODE

- 2. ANODE
- 3. GATE ANODE

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